

Electronic Acknowledgement Receipt

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Application Number:	10675455
International Application Number:	
Confirmation Number:	5598
Title of Invention:	Photosensitive resin composition controlling solubility and pattern formation method of double-layer structure using the same
First Named Inventor/Applicant Name:	Seok-Yoon Yang
Customer Number:	23413
Filer:	Jaegyoo Jang
Filer Authorized By:	
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Document Number	Document Description	File Name	File Size (Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed (SB/08)	PNK0062IDS.pdf	609871 bca0117a7412a7118c3da5c27e1eb0c801d5548	no	4
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2	Foreign Reference	JP05273411.pdf	825456 b6d92c1991ee02ff317ca86075a62254118c01cc16	no	9
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5	Foreign Reference	20020054539A.pdf	748195 bf7c11c79a337a55cd51b9ba8a5f6267828c9	no	12
Warnings:					
Information:					
6	Fee Worksheet (PTO-06)	fee-info.pdf	29931 476569b35781d33286a0119ebc3c3251ac7ba0505	no	2
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National Stage of an International Application under 35 U.S.C. 371

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New International Application Filed with the USPTO as a Receiving Office

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